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### **Problem and research questions**

SPIE.

Two-level systems (TLSs) in deposited dielectrics cause dielectric loss<sup>1</sup> and frequency noise<sup>2</sup> in superconducting resonators used in spectrometers<sup>3,4,5</sup>.



#### **Microwave dielecric loss**





Fig. I Schematic of a-Si:H. Grey: Si atoms. Blue: H atoms. The SiH<sub>2</sub> bonds exist on the surface of voids.

What is the microscopic origin of the TLSs in hydrogenated amorphous silicon (a-Si:H)?

What is the effect of depositing by PECVD at elevated substrate temperatures<sup>6</sup> ( $T_{sub}$ )?

Hydrogen content, microstructure parameter, infrared refractive index

	<b>TOO TOO 200</b>	100 200 300
T <sub>sub</sub> (°C)	T <sub>sub</sub> (°C)	T <sub>sub</sub> (°C)

Fig. III Hydrogen content ( $C_{\rm H}$ ) microstructure parameter  $(R^{*})$ , and infrared refractive index  $(n_{ir})$  determined by FTIR spectroscopy. A larger  $R^*$  indicates more voids.

The hydrogen content ( $C_{\rm H}$ ), microstructure parameter ( $R^*$ ), and infrared refractive index ( $n_{ir}$ ) show a monotonic dependence on  $T_{sub}$ .

# **Bond-angle disorder**

The bond-angle disorder ( $\Delta \theta$ ) decreases mono-

tonically with increasing  $T_{sub}$ .



Fig. VI Micrograph of one of the aluminum quarterwavelength coplanar waveguide (CPW) resonators that we used to measure the loss tangent (tan $\delta$ ) at 120 mK and at 5-7 GHz. The chip contains multiple CPW geometries.

We do not observe a correlation of the microwave dielectric loss with  $T_{sub}$ .



The microstructure of a-Si:H is goverend by the occcurence of hydrogen bonds<sup>7</sup>.



Fig. IV The bond-angle disorder determined by Raman spectroscopy.

### Void volume fraction

The void volume fraction  $(f_v)$  decreases mono-

tonically with increasing  $(T_{sub})$ .



Fig. VII The loss tangents (tan $\delta$ ) that we estimated by referencing to a chip directly on top of the c-Si substrate. The x-axis shows the number of photons in the resonator. The symbols denote the CPW slot and line widths.

## Conclusions

The PECVD substrate temperature controls the microstructure and composition of a-Si:H.

We do not observe a correlation of the room 2. temperature properties with the 120-mK

Fig. II Fourier-transform infrared (FTIR) absorption coefficient ( $\alpha$ ) measurements, showing the stretching and wagging modes from which we determined the hydrogen content ( $C_H$ ) and the microstructure parameter ( $R^*$ )<sup>7</sup>.

Fig. V The void volume fraction determined by ellipsometry using the Bruggeman effective medium approximation.

microwave dielectric loss at a resonator energy of ~  $10^4 - 10^6$  photons.



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